

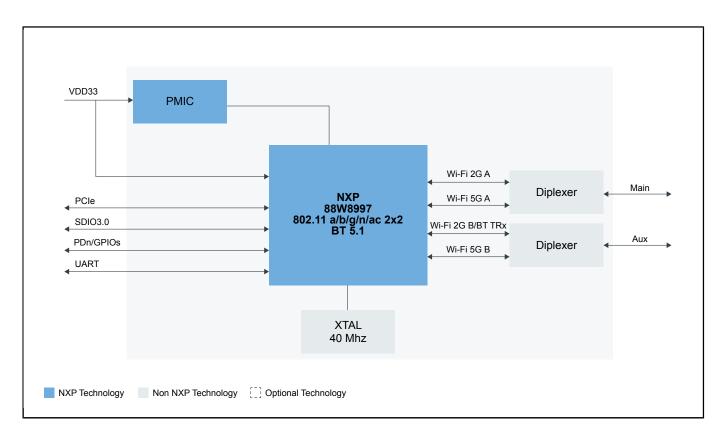
Advantech's EWM-W306: NXP 88W8997 M.2 1216

EWM-W306

Last Updated: Jun 22, 2023

Advantech EWM-W306 is NXP88W8997 M.2 1216 solder down module, supporting 802.11ac and Bluetooth® 5.1 2x2 dual band. This wide range temperature module can use in medical device, handheld device, industrial application, embedded board and transportation.

EWM-W306 Block Diagram Block Diagram



View additional information for Advantech's EWM-W306: NXP 88W8997 M.2 1216.

Note: The information on this document is subject to change without notice.

www.nxp.com

NXP and the NXP logo are trademarks of NXP B.V. All other product or service names are the property of their respective owners. The related technology may be protected by any or all of patents, copyrights, designs and trade secrets. All rights reserved. © 2025 NXP B.V.